# 74LVC162244A; 74LVCH162244A

16-bit buffer/line driver; 30  $\Omega$  series termination resistors; 5 V tolerant input/output; 3-state

Rev. 6 — 16 December 2011

Product data sheet

### 1. General description

The 74LVC162244A; 74LVCH162244A are 16-bit non-inverting buffer/line drivers with 3-state bus compatible outputs. The device can be used as four 4-bit buffers, two 8-bit buffers or one 16-bit buffer. It features four output enable inputs, ( $\overline{10E}$  to  $\overline{40E}$ ) each controlling four of the 3-state outputs. A HIGH on  $\overline{n0E}$  causes the outputs to assume a high-impedance OFF-state. The device is designed with  $30~\Omega$  series termination resistors in both HIGH and LOW output stages to reduce line noise.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH162244A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

#### 2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when V<sub>CC</sub> = 0 V
- All data inputs have bus hold. (74LVCH162244A only)
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - ♦ MM JESD22-A115-B exceeds 200 V
  - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

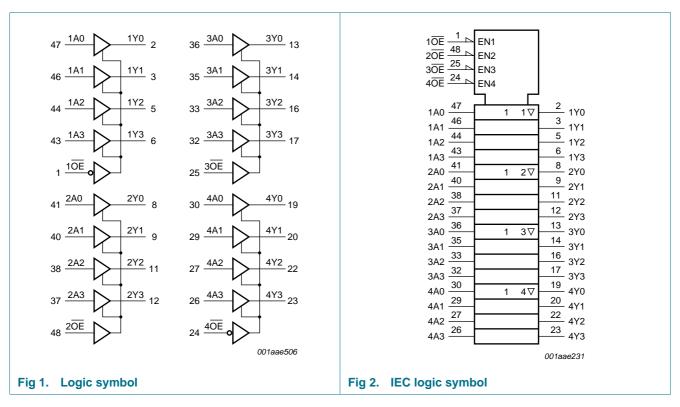


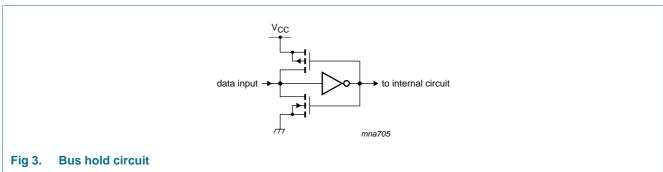
# 3. Ordering information

Table 1. Ordering information

Type number	Temperature range	Package			
		Name	Description	Version	
74LVC162244ADL	−40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads;	SOT370-1	
74LVCH162244ADL			body width 7.5 mm		
74LVC162244ADGG	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1	
74LVCH162244ADGG	_		48 leads; body width 6.1 mm		

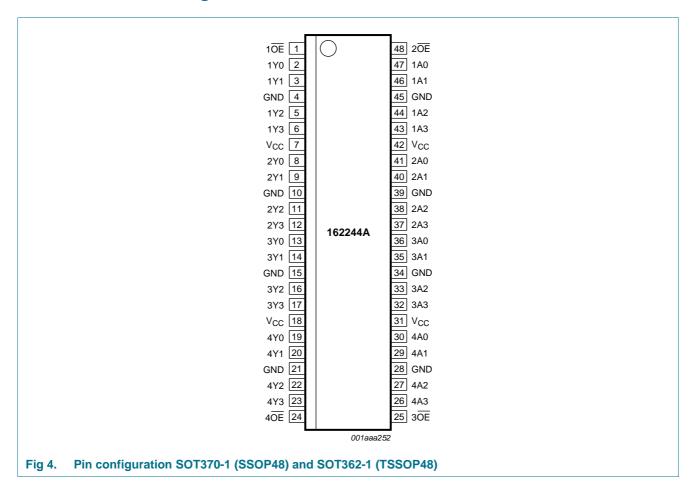
# 4. Functional diagram





# 5. Pinning information

#### 5.1 Pinning



#### 5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1 <del>OE</del>	1	output enable input (active LOW)
2 <del>OE</del>	48	output enable input (active LOW)
3 <del>OE</del>	25	output enable input (active LOW)
4 <del>OE</del>	24	output enable input (active LOW)
GND	4, 10, 15, 21, 28, 34, 39, 45	ground (0 V)
$V_{CC}$	7, 18, 31, 42	supply voltage
1A[0:3]	47, 46, 44, 43	data input
2A[0:3]	41, 40, 38, 37	data input
3A[0:3]	36, 35, 33, 32	data input
4A[0:3]	30, 29, 27, 26	data input
1Y[0:3]	2, 3, 5, 6	data output

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Table 2. Pin description ...continued

Symbol	Pin	Description
2Y[0:3]	8, 9, 11, 12	data output
3Y[0:3]	13, 14, 16, 17	data output
4Y[0:3]	19, 20, 22, 23	dataoutput

# 6. Functional description

Table 3. Function table[1]

Control	Input	Output
nOE	nAn	nYn
L	L	L
L	Н	Н
Н	X	Z

<sup>[1]</sup> H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

# 7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
$I_{IK}$	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
$V_{I}$	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0 V$	-	±50	mA
Vo	output voltage	output HIGH or LOW	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
$P_{tot}$	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C};$	[3] -	500	mW
	<u> </u>	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C};$			

<sup>[1]</sup> The minimum input voltage ratings may be exceeded if the input current ratings are observed.

<sup>[2]</sup> The output voltage ratings may be exceeded if the output current ratings are observed.

<sup>[3]</sup> Above 60 °C the value of Ptot derates linearly with 5.5 mW/K.

# 8. Recommended operating conditions

Table 5. Recommended operating conditions

	_	<u> </u>		_		
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{CC}$	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW	0	-	$V_{CC}$	V
		output 3-state	0	-	5.5	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

#### 9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	-40 °C t	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	Ī
$V_{IH}$	HIGH-level	V <sub>CC</sub> = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
$V_{IL}$	LOW-level	V <sub>CC</sub> = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V <sub>OH</sub> HIGH-level output voltage		$V_I = V_{IH}$ or $V_{IL}$						
	•	$I_O = -100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	V <sub>CC</sub> - 0.2	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -2 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.7	-	-	1.55	-	V
		$I_{O} = -6 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
$V_{OL}$	LOW-level	$V_I = V_{IH}$ or $V_{IL}$						
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 \text{ V to } 3.6 \text{ V}$	-	-	0.2	-	0.3	V
		$I_O = 2 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_{O} = 4 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_O = 6 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V V V V V V V V V V V V V V V V V V V
		$I_O = 12 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
l <sub>l</sub>	input leakage current	$V_{CC} = 3.6 \text{ V};$ $V_{I} = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μА

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 Table 6.
 Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions			-40	°C to +	85 °C		-40 °C t	o +125 °C	Unit
					Min	Typ[1]	Max		Min	Max	
l <sub>OZ</sub>	OFF-state output current	$V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 3.6$ V; $V_O = 5.5$ V or GND;	[2]	-		±0.1	±5	-		±20	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$		-		±0.1	±10	-		±20	μА
I <sub>CC</sub>	supply current	$V_{CC} = 3.6 \text{ V};$ $V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A}$		-		0.1	20	-		80	μΑ
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_{I} = V_{CC} - 0.6 \text{ V}; I_{O} = 0 \text{ A}$		-		5	500	-		5000	μА
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_{I} = \text{GND to } V_{CC}$		-		5.0	-	-		-	pF
I <sub>BHL</sub>	bus hold	$V_{CC} = 1.65; V_I = 0.58 V$	[3][4]		10	-	-		10	-	μΑ
	LOW current	$V_{CC} = 2.3; V_I = 0.7 V$			30	-	-		25	-	μΑ
		$V_{CC} = 3.0; V_I = 0.8 V$			75	-	-		60	-	μΑ
I <sub>BHH</sub>	bus hold	$V_{CC} = 1.65; V_I = 1.07 V$	[3][4]		-10	-	-		-10	-	μΑ
	HIGH current	$V_{CC} = 2.3; V_I = 1.7 V$			-30	-	-		-25	-	μΑ
		$V_{CC} = 3.0; V_I = 2.0 V$			<b>-75</b>	-	-		-60	-	μΑ
I <sub>BHLO</sub>	bus hold	V <sub>CC</sub> = 1.95 V	[3][5]		200	-	-		200	-	μΑ
	LOW overdrive	V <sub>CC</sub> = 2.7 V			300	-	-		300	-	μΑ
	current	V <sub>CC</sub> = 3.6 V			500	-	-		500	-	μΑ
Івнно	bus hold	V <sub>CC</sub> = 1.95 V	[3][5]		-200	-	-		-200	-	μΑ μΑ μΑ μΑ μΑ μΑ μΑ μΑ μΑ μΑ
	HIGH overdrive	V <sub>CC</sub> = 2.7 V			-300	-	-		-300	-	
	current	V <sub>CC</sub> = 3.6 V			-500	-	-		-500	-	μΑ

<sup>[1]</sup> All typical values are measured at  $V_{CC}$  = 3.3 V and  $T_{amb}$  = 25 °C.

<sup>[2]</sup> The bus hold circuit is switched off when  $V_I > V_{CC}$  allowing 5.5 V on the input terminal.

<sup>[3]</sup> Valid for data inputs only. Control inputs do not have a bus hold circuit.

<sup>[4]</sup> The specified sustaining current at the data input holds the input below the specified  $V_I$  level.

<sup>[5]</sup> The specified overdrive current at the data input forces the data input to the opposite logic input state.

# 10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[2]	Max	Min	Max	
t <sub>pd</sub>	propagation	nAn to nYn; see Figure 5	<u>[1]</u>						
	delay	V <sub>CC</sub> = 1.2 V		-	11.0	-	-	-	ns
		V <sub>CC</sub> = 1.65 V to 1.95 V		1.5	6.0	15.0	1.5	17.2	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.2	7.4	1.0	8.2	ns
		V <sub>CC</sub> = 2.7 V		1.0	3.3	6.7	1.0	8.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.7	5.8	1.0	7.5	ns
t <sub>en</sub>	enable time	nOE to nYn; see Figure 6	[1]						
		V <sub>CC</sub> = 1.2 V		-	15.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.7	6.8	15.3	1.7	17.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.5	3.8	8.0	1.5	8.9	ns
		V <sub>CC</sub> = 2.7 V		1.5	4.2	7.6	1.5	9.5	ns
		V <sub>CC</sub> = 3.0 V to 3.6 V		1.0	3.1	6.0	1.0	7.5	ns
t <sub>dis</sub>	disable time	nOE to nYn; see Figure 6	<u>[1]</u>						2 ns 5 ns 5 ns 7 ns 9 ns 5 ns 6 ns 7 ns 9 ns 7 ns 9 ns 7 ns 9 ns 7 ns 9 ns 7 ns
		V <sub>CC</sub> = 1.2 V		-	10.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.2	3.9	8.2	2.2	9.5	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		0.5	2.1	4.4	0.5	5.0	ns
		V <sub>CC</sub> = 2.7 V		1.5	3.1	4.7	1.5	6.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.5	2.8	4.5	1.5	6.0	ns
$C_{PD}$	power	per input; $V_I = GND$ to $V_{CC}$	<u>[3]</u>						
	dissipation capacitance	V <sub>CC</sub> = 1.65 V to 1.95 V		-	4.8	-	-	-	pF
	capacitarice	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	8.3	-	-	-	pF
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	11.4	-	-	-	pF

<sup>[1]</sup>  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

 $t_{\text{en}}$  is the same as  $t_{\text{PZL}}$  and  $t_{\text{PZH}}.$ 

 $t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

C<sub>L</sub> = output load capacitance in pF

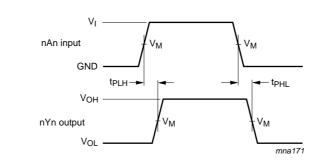
V<sub>CC</sub> = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

<sup>[2]</sup> Typical values are measured at  $T_{amb}$  = 25 °C and  $V_{CC}$  = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

#### 11. Waveforms



Measurement points are given in Table 8.

Logic levels:  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 5. The input (nAn) to output (nYn) propagation delays

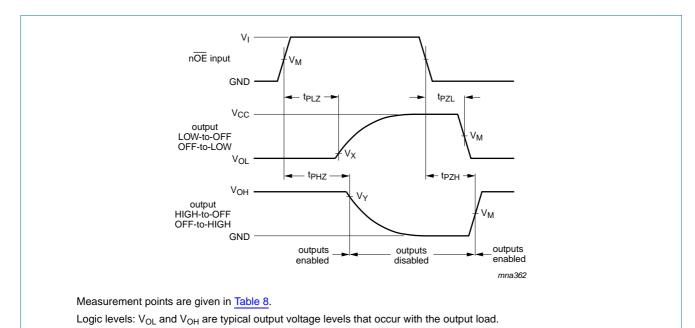
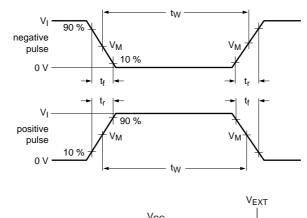
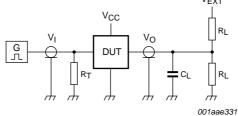


Fig 6. 3-state enable and disable times.

Table 8. Measurement points

Supply voltage	V <sub>M</sub>	Input		Output		
V <sub>CC</sub>		VI	$t_r = t_f$	V <sub>X</sub>	V <sub>Y</sub>	
1.2 V	$0.5 \times V_{\text{CC}}$	V <sub>CC</sub>	$\leq$ 2.5 ns	V <sub>OL</sub> + 0.15 V	$V_{OH}-0.15\ V$	
1.65 V to 1.95 V	$0.5 \times V_{CC}$	V <sub>CC</sub>	≤ 2.5 ns	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V	
2.3 V to 2.7 V	$0.5 \times V_{CC}$	V <sub>CC</sub>	≤ 2.5 ns	V <sub>OL</sub> + 0.15 V	V <sub>OH</sub> – 0.15 V	
2.7 V	1.5 V	2.7 V	≤ 2.5 ns	$V_{OL}$ + 0.3 $V$	$V_{OH} - 0.3 V$	
3.0 V to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns	$V_{OL}$ + 0.3 $V$	$V_{OH} - 0.3 V$	





Test data is given in Table 9.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.

V<sub>EXT</sub> = External voltage for measuring switching times.

Fig 7. Test circuit for measuring switching times

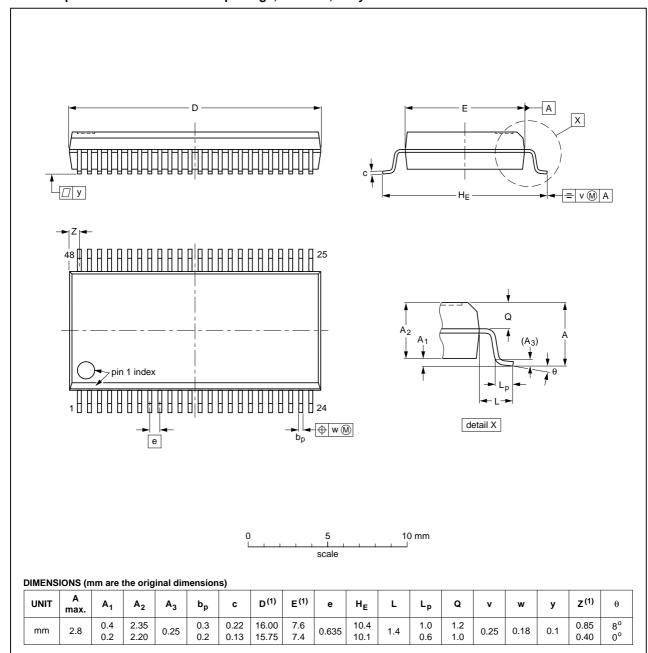
Table 9. Test data

Supply voltage	Input		Load		V <sub>EXT</sub>		
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	$t_{PLZ}, t_{PZL}$	t <sub>PHZ</sub> , t <sub>PZH</sub>
1.2 V	$V_{CC}$	≤ 2 ns	30 pF	1 k $\Omega$	open	$2\times V_{CC}$	GND
1.65 V to 1.95 V	$V_{CC}$	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND
2.3 V to 2.7 V	$V_{CC}$	≤ 2 ns	30 pF	$500 \Omega$	open	$2\times V_{CC}$	GND
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	$2\times V_{CC}$	GND

# 12. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



#### Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

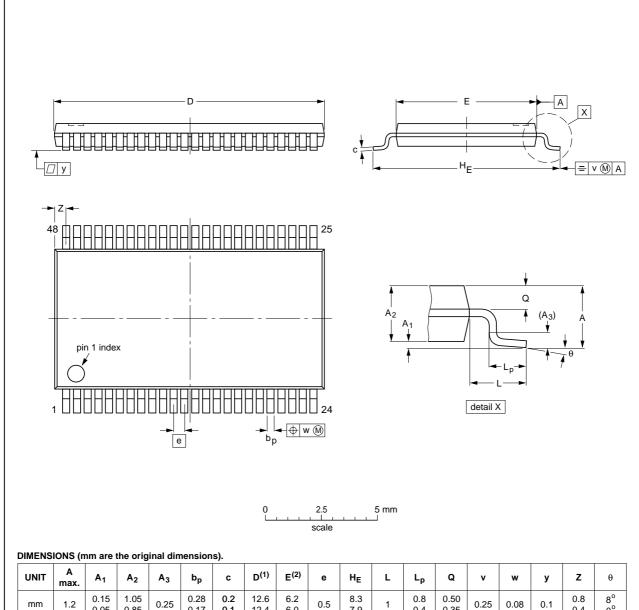
OUTLINE		REFER	ENCES	EUROPEAN	99-12-27 03-02-19	
VERSION	IEC	JEDEC JEITA		PROJECTION	155UE DATE	
SOT370-1		MO-118			<del>99-12-27</del> 03-02-19	

Fig 8. Package outline SOT370-1 (SSOP48)

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#### TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1 mm

SOT362-1



UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	С	D <sup>(1)</sup>	E <sup>(2)</sup>	е	HE	L	Lp	Q	v	w	у	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	12.6 12.4	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.8 0.4	8° 0°

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE	
SOT362-1		MO-153				<del>99-12-27</del> 03-02-19	

Fig 9. Package outline SOT362-1 (TSSOP48)

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#### 13. Abbreviations

#### Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

# 14. Revision history

#### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC_LVCH162244A v.6	20111216	Product data sheet	-	74LVC_LVCH162244A v.5
Modifications:		propagation delay value ns to 17.2 ns	for $V_{CC} = $	1.65 V to 1.95 V at +125 °C changed
	<ul><li>Maximum 16.1 ns to</li></ul>	•	<sub>C</sub> = 1.65 V	to 1.95 V at +125 °C changed from
	<ul><li>Maximum</li><li>8.7 ns to 9</li></ul>	-	<sub>CC</sub> = 1.65 \	/ to 1.95 V at +125 °C changed from
74LVC_LVCH162244A v.5	20111108	Product data sheet	-	74LVC_LVCH162244A v.4
Modifications:		t of this document has be of NXP Semiconductors		gned to comply with the new identity
	<ul> <li>Legal texts</li> </ul>	s have been adapted to t	he new co	mpany name where appropriate.
	• <u>Table 5, Ta</u>	able 6, <u>Table 7</u> and <u>Table</u>	9: values	added for lower voltage ranges.
74LVC_LVCH162244A v.4	20031212	Product specification	-	74LVC_H162244A v.3
74LVC_H162244A v.3	19980217	Product specification	-	74LVC162244A_LVCH162244A v.3
74LVC162244A_LVCH162244A v.3	19980217	Product specification	-	74LVC162244A v.2
74LVC162244A v.2	19970801	Product specification	-	74LVC162244A v.1

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Document status[1][2]	Product status[3]	Definition					
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.					
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# 74LVC162244A; 74LVCH162244A

16-bit buffer/line driver; 30  $\Omega$  resistors; 5 V tolerance; 3-state

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#### **NXP Semiconductors**

16-bit buffer/line driver; 30  $\Omega$  resistors; 5 V tolerance; 3-state

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